

Novo® Series: Model 460

Selective Soldering with combined Flexibility and Modularity

Features and Benefits

- Choice of single or dual drop-jet fluxers and solder pots for either simultaneous parallel or independent double processing modes
- Parallel processing significantly increases machine through put while double processing broadens soldering flexibility
- Full titanium solder pot compatible with all solder alloys plus easy tool-free maintenance
- Software control between different solder alloys without changing solder pots
- Standalone platform with combined fluxing, preheating and soldering for highest possible process flexibility

Technical Specification

Motion System

Z accuracy $\pm 100~\mu m$ (0.004 in.)

Z repeatability (1) $\pm 50 \,\mu\text{m}$ (0.002 in.), 3 sigma Z velocity 0.05 m/s peak (2 in./s) X-Y accuracy $\pm 100 \,\mu\text{m}$ (0.004 in.)

X-Y repeatability (1) $\pm 50 \mu m$ (0.002 in.), 3 sigma X-Y velocity 0.2 m/s peak (8 in./s)

Computer PC with Windows® operating system

Software PhotoScan "point-and-click" programming editor and machine control software

Solder Pot Capacity and Weight

Capacity (2) Approx. 12.0 kg (26.4 lbs.)
Total weight of tin-lead solder together with Approx. 22.4 kg (49.2 lbs.)

solder pot and pump assembly (2)

Total weight of lead-free solder together with Approx. 19.7 kg (43.3 lbs.)

solder pot and pump assembly (2)

Max. temperature 320°C

Solderable Area (X-Y)

Single, parallel or double operating mode (3, 4): Max. 460 x 460 mm (18.1 x 18.1 in.)

Preheating Selectable infrared preheating from 1.5 kW to 6.0 kW

Board Handling Capability

Max. board size 460 x 460 mm (18.1 x 18.1 in.)

Board Clearance

Max. overboard clearance 120 mm (4.7 in.)
Max. under board clearance 40 mm (1.5 in.)

